

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Shian-Jyh Lin	04/15/2010
RECEIVING PARTY DATA	
Name:	NANYA TECHNOLOGY CORP.
Street Address:	Hwa-Ya Technology Park 669, Fuhsing 3 Rd., Kueishan
City:	Tao-Yuan Hsien
State/Country:	TAIWAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12761413
CORRESPONDENCE DATA	
Fax Number: (703)997-4517 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i> Phone: 3027291562 Email: Patent.admin.uspto.cr@naipo.com Correspondent Name: WINSTON HSU Address Line 1: P.O.BOX 506 Address Line 4: Merrifield, VIRGINIA 22116	
ATTORNEY DOCKET NUMBER:	NTCP0339USA
NAME OF SUBMITTER:	SERENE CHANG
Total Attachments: 2 source=825332#page1.tif source=825332#page2.tif	

CH \$40.00 12761413

501149744

PATENT
 REEL: 024241 FRAME: 0691

ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

ASSIGNOR(S) (Inventors):

Name: Shian-Jyh Lin Nationality: TW

Hereby sells, assigns and transfers to

ASSIGNEE(S):

Name: NANYA TECHNOLOGY CORP.

Address: Hwa-Ya Technology Park 669, Fuhsing 3 Rd., Kueishan, Tao-Yuan Hsien, Taiwan, R.O.C.

and the successors and assignees of the ASSIGNEE the entire right, title, and interest in and to any and all improvements which are disclosed in the invention entitled:

"SEMICONDUCTOR DEVICE WITH THROUGH SUBSTRATE VIA"

Which is found in :

- (a) + U.S. patent application executed on even date
(b) _____ U.S. patent application executed on _____
(c) _____ U.S. application serial no. _____
(d) _____ patent no. _____ issued _____

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We have hereunto set hand and seal this APR 15 2010 (Date of signing). (請發明人務必簽署上列日期。)

(Type name of inventor)

Shian-Jyh Lin

Signature of INVENTOR

Shian-Jyh Lin